

NEXT

IN THE SPOTLIGHT **MICROELECTRONICS**

STORIES, FACTS AND FIGURES

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Microelectronics ...

(sometimes synonymously semiconductors)

describes the design and manufacture of thousands of tiny integrated circuits (ICs) within a single device, the „chip“. In most cases, the basic material of this chip is silicon, which is processed by semiconductor factories (fabs) on so called wafers, thin circular slices of the material. Here, insulating or conductive layers are applied in numerous complex process steps. This is how electronic components, for example transistors and capacitors, are realized, which can be combined depending on the desired function of the chip. The production process ends with packaging, in which in some cases several thousand chips are separated from one another and placed in a package, as well as an elaborate test procedure. Basically, it can be said that as the size of the transistors decreases, the performance of the chip increases, but the production also becomes more complex and expensive. Chips are used today in all technical devices - from alarm clocks and cell phones to industrial robots.

THE TOP 3 CHIP MANUFACTURERS

WORLDWIDE

(BY SALES IN USD BILLIONS)

1. SAMSUNG (SÜDKOREA) - 75,9
2. INTEL (USA) - 73,1
3. TSMC (TAIWAN) - 56,8

EUROPE

(BY SALES IN € BILLIONS)

1. ST MICROELECTRONICS (SCHWEIZ) - 11,2
2. INFINEON (DEUTSCHLAND) - 11,0
3. NXP (NIEDERLANDE) - 9,7

*Source: Statista, FAZ



Dear readers,

Production stops, delivery difficulties, price increases - the semiconductor shortage highlighted the importance of the microelectronics industry. In Saxony, too, work is continuing to end the shortage - with excellent research, new materials, forward-looking technologies and fully automated factories. Our booklet provides an overview of all relevant topics relating to microelectronics. It also offers the opportunity to obtain in-depth information online. Look forward to exciting details on chip production, application areas, future-proof jobs and the immensely important promotion of the industry. You will be amazed at the importance of microelectronics in your life.

Enjoy reading,

Yvonne Keil

Sr. Director Global Supply Management | GlobalFoundries Dresden
Board member | Silicon Saxony

Table of contents

- 4-5 **Microelectronics in Saxony, Germany and Europe**
- 6-7 **Chip production & fabs**
- 8-9 **Location & competition**
- 10-11 **Professionals & skills**
- 12-13 **New materials**
- 14-15 **Technology trends**
- 16-17 **European Chips Act**
- 18 **Jobs**

Photos:
Micro Chips: Tilo Up
Silicon Saxony: p. 6, 7, 15
GlobalFoundries Dresden: p. 8, 11
Robert Bosch Semiconductor Manufactu-
ring Dresden: p. 6, 7, 14, 15
Infineon Technologies Dresden: p. 8, 11
SAW COMPONENTS Dresden & X-FAB
Dresden: p. 8
Federal Ministry of Economics: p. 7
Fraunhofer IEP: p. 10

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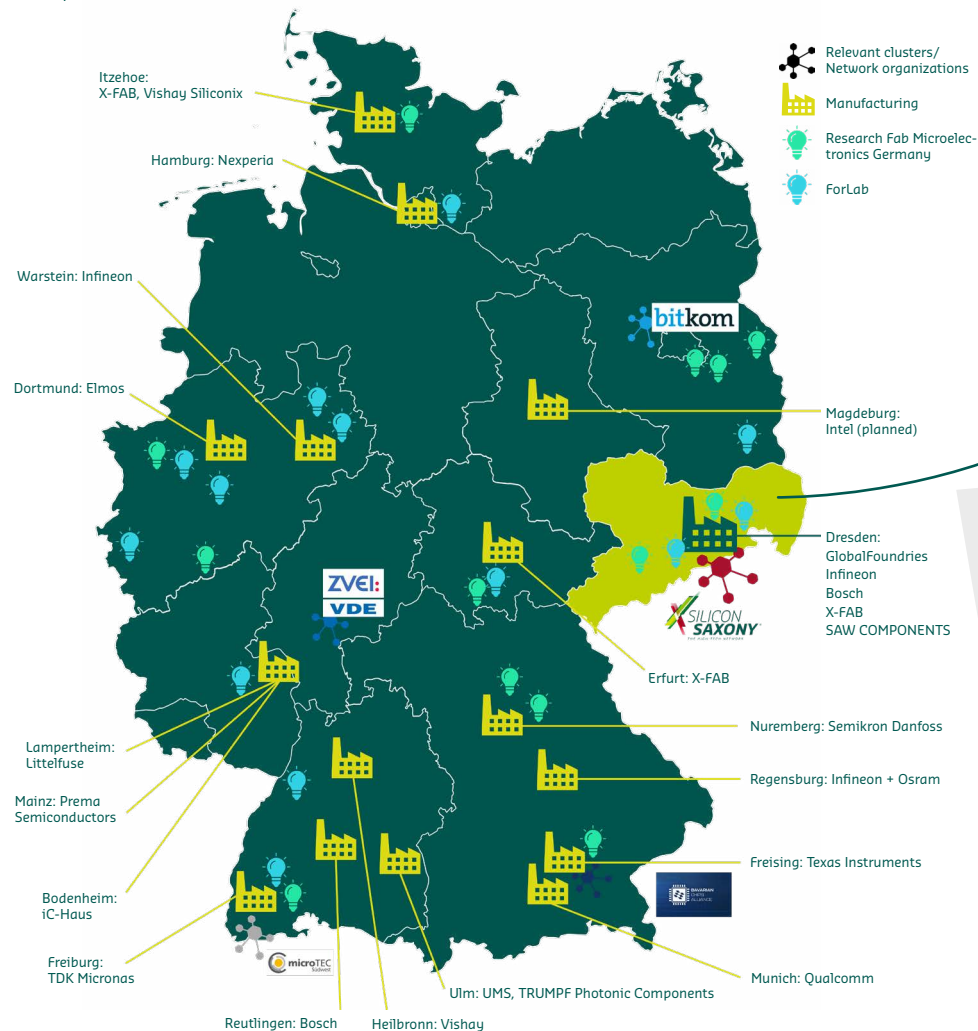
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Germany's microelectronics landscape - Europe's semiconductor heart beats here

Absolutely cutting-edge research, world-class product development, highly and fully automated production factories - the semiconductor heart of Europe beats in Germany. Locations such as the microelectronics valley Silicon Saxony have long since made a name for themselves worldwide. But where are the chips of tomorrow actually being developed? Where are the industry's major fabs located? Which companies and institutions shape the German semiconductor market? Our location map provides a quick overview.



Silicon Saxony in numbers

> 1 million wafers processed per year

Approx. **113,000 square meters** of cleanroom space

51 educational and research institutes

> 40,000 employees work directly and indirectly in the microelectronics industry

5 fabs at one location

Every 3rd microchip produced in Europe is „Made in Saxony“



GET TO KNOW THE +400 MEMBERS OF SILICON SAXONY



„It is not about competition within Europe. It's about Europe's position in global competition.“

Frank Bösenberg, Managing Director | Silicon Saxony

To remain internationally competitive, the microelectronics industry in Europe must cooperate more closely. Silicon Saxony has therefore been involved in the Silicon Europe Alliance - a network of eleven European cluster partners - since 2012 and is also active in the EU projects ASCENT+, Eurocluster, METIS and EXCITE.

LEARN MORE ABOUT OUR EUROPEAN COOPERATION PROJECTS



Saxony's chip industry strengthens its supply chains

Wafers, spare parts, gases - Microelectronics logistics must manage material flows around the globe

In the past two years, the discussion about disrupted value chains has focused strongly on missing chips for the automotive industry. Rather little public attention has been paid to what a sophisticated high-tech product the microelectronic circuit is and what complex paths lead from sand to chip. It is therefore even more remarkable that most semiconductor manufacturers have been comparatively successful in keeping their own value streams flowing.

This task is demanding: To manufacture a microelectronic circuit, you need high-purity silicon, targets for the ion implanters, noble gases, aqua regia and many other chemicals, equipment costing millions, know-how accumulated over decades and an excellent system to coordinate thousands of people and process steps around the globe. De-globalization in the semiconductor industry? Difficult, because no single country is able to realize all links of the semiconductor value chain entirely within its own borders. Some chips travel two and a half times around the globe from sand to assembly at the end user.

Do you want to know how complex the process is in detail, what supply flows look like, why companies are expanding a multi-source approach, and what the energy supply situation is like for semiconductor fabs in times of energy crisis?



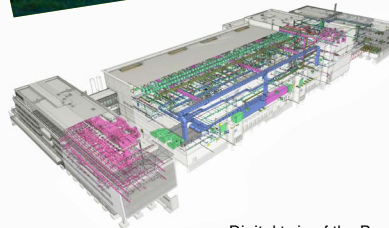
CONTINUE
READING THE
ENTIRE ARTICLE
ONLINE



Why are semiconductor factories so expensive?



Bosch's fully automated fab in Dresden is one of the most modern in Europe



Digital twin of the Bosch fab



Facts & Figures

2.5 times around the earth. This is the distance some chips cover from sand to the final consumer.

1 trillion chips are installed worldwide every year.

8.5 million tons of silicon are extracted worldwide every year. The largest producers are China, Russia, Brazil, Norway and the USA.

On average, **25 countries** are directly involved in each stage of the semiconductor value chain, and another 23 countries are indirectly involved.

Some circuits cross **up to 70** country borders from the start of production to delivery to the customer.

Sources: Ifo Dresden, Bosch, Federal Institute for Geosciences and Natural Resources, Statista, GlobalFoundries, Accenture.



Read how the German government is supporting the microelectronics industry in international competition in a statement by Robert Habeck, Germany's Minister of Economics.



Why Robert Habeck speaks from the soul of the Dresden fabs...



Saxony's fabs in interview

How do the managers of the Saxon fabs view the location? What role does the network play? Where does cooperation end and competition begin? Our interviews reveal the answer.



[We] need [...] support at all levels of government. [...] This includes not only funding programs, but also an environment that attracts skilled workers from other regions. Only in this way can the European microelectronics industry survive in global competition.

Raik Brettschneider, Vice President & Managing Director | Infineon Technologies Dresden



Our goal is to make SAW COMPONENTS a cross-industry provider of thin film technology and lithography at the Dresden site. For this purpose, we cooperate with Saxon partners from industry and research and at the same time we see a tough competition for talents.

Steffen Zietzschmann, CEO | SAW COMPONENTS Dresden



„Silicon Saxony“ has the potential to become the center of modern, forward-looking manufacturing - the home of Industry 4.0. By 2026, Bosch Dresden [...] will invest not only in additional manufacturing capacity [...] but also in research and development.

Dr. Christian Koitzsch, Plant Manager | Robert Bosch Semiconductor Manufacturing Dresden



A location like Dresden [...] is unique in Europe. This has an appeal beyond Saxony and leads to skilled workers coming to the region. But of course, competition also increases the competition for talent.

Rico Tillner, Managing Director | X-FAB Dresden



In Germany and Europe, we need greater ambition, higher budgets, a much faster pace and, above all, a focus on implementation. Only if these four aspects are addressed with equal speed and sustainability, we can remain successful.

Dr. Manfred Horstmann, Sr. Vice President & General Manager | GlobalFoundries Dresden

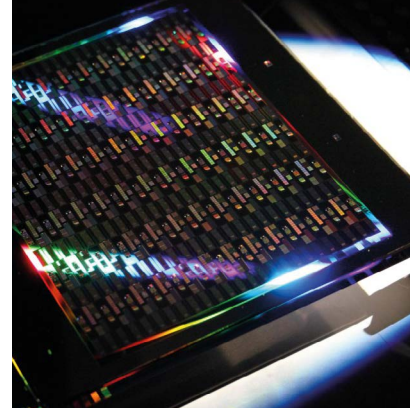
READ THE COMPLETE INTERVIEWS:



	Infineon Technologies Dresden	SAW COMPONENTS Dresden	Robert Bosch Semiconductor Manufacturing Dresden	X-FAB Dresden	GlobalFoundries Dresden
Opening	1994	1993	2021	1981	1999
Size of the fab	300,000 sqm	4,000 sqm	100,000 sqm	81,000 sqm	407,000 sqm
Clean room size	40,000 sqm	1,800 sqm	13,000 sqm	3,800 sqm	52,000 sqm
Employees at the site	3,200	33	> 400	540	3,400
Share of women	25 %	40 %	customary in the industry	22 %	16 %

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Jobs with a future

European semiconductor manufacturers and their suppliers are suffering from an increasing shortage of skilled workers.

The EU METIS project analyzed, among other things, which job profiles and soft skills are in particular demand. We put a face to four of these professions and asked about tasks and the special appeal of the specific fields of activity.



SIX FURTHER JOB PROFILES INCL. DETAILS ON ACCESS, PROFESSIONAL AND PERSONAL REQUIREMENTS, TASKS AND EARNING OPPORTUNITIES CAN BE FOUND ONLINE



IC-Designer

Dirk Schlebusch
System Design Engineer for Microdisplays and Sensors, Fraunhofer FEP

The most exciting moment for me is when my layout is realized on a chip - when I see that what I have thought about before actually works. This magic of technology fascinates me.



Robotics Engineer

Feryel Zoghliami
Senior Engineer Sensor Fusion, Development Center, Infineon Technologies Dresden

I love to research. As a robotics engineer, I can pursue this passion, put new findings straight into practice and directly observe how the robots react.

Top 5 professions in microelectronics*

1. Design Engineer

2. Software Engineer & Developer

3. Process Engineer

4. Test Engineer

5. Maintenance Technician/ Maintainer

Top 5 soft skills*

1. Ability to work in a team

2. Creativity

3. Communication skills

4. Problem solving skills

5. Leadership quality

*Source: EU-project „METIS“

OUR MICROELECTRONICS WORKING GROUPS: NETWORKING, EXCHANGE OF EXPERIENCES AND TECHNOLOGY INSIGHTS



Equipment Engineer

Patrick Mülverstedt
Equipment Engineer, Robert Bosch Semiconductor Manufacturing Dresden GmbH

Due to the large number of technical systems I support, exciting situations arise on a permanent basis. We analyze these intensively, discuss them at the desk and then actively implement them on the system and in the team.



Process Technician

Djamila Steinich
Senior Technician Production Planning & Control, GlobalFoundries Dresden

I appreciate the responsibility that my team and I have to ensure that at the end of production our customers receive their order in the desired quality, quantity and at the right time.



CHANGE THE WORLD - AN EXCITING STORY ABOUT THE POSSIBILITIES OF IC DESIGN

What the chips of the future are made of

Magnetic stacks with materials such as cobalt-iron-boron or iridium-platinum compounds, magnesium oxide, etc.

Advantages:

- fast storage capability
- low voltage

Disadvantages:

- separation of the materials is complex and expensive
- industry still has little experience with it

Application:

- memory cells embedded in logic circuits or other complex systems

**Metal oxide semiconductors
such as indium tin oxide (ITO)
and indium gallium zinc oxide
(IGZO)**

Advantage:

- can be processed at low temperatures
- important for layer build-up!

Disadvantage:

- unlike silicon, these metal oxides are not single crystals, their charge carrier mobility is lower
- i.e. it may be more difficult to achieve a high switching speed

Application:

- highly integrated electronics for autonomous cars, smartphones, data centers, control electronics in factories, etc

[illegible]

"Only about 25 years ago, the number of materials that were important for microelectronics was very manageable. Since then, this number has really exploded and the semiconductor technology has expanded to include a large part of the periodic table."

Prof. Dr. Thomas Mikolajick
TU Dresden | Director NaMLab

- used before 1980
- added in 1990
- discovered and added in 2000
- discovered and added in 2010

Tantalum oxides and amorphous hafnium oxide

Advantage:

- inexpensive

Disadvantages:

- only withstands a relatively low number of switching cycles
- high statistical fluctuation from switching cycle to switching cycle
- industry still has little experience with it

Applications:

- currently in demand primarily as a low-cost alternative to flash memory cells
- perspective as hardware for certain computational tasks of artificial intelligence (AI)

Crystalline hafnium oxide

Advantages:

- as a memory in performance and efficiency a quantum leap compared to flash
- easy to integrate into existing CMOS processes

Disadvantages:

- tolerates only a few million switching cycles
- relatively high voltage compared to MRAM (about 3 volts)

Applications:

- very fast memory with very low power consumption
- perspective: neuromorphic computing for artificial intelligences



**FURTHER MATERIAL
GROUPS AND DETAILS
AS WELL AS OUR
CONCLUSION CAN BE
FOUND ONLINE**

Technology trends: Quantum computing, neuromorphic computers and tap-proof telephony

How Saxony's engineers are working on the future

In the past decades, the semiconductor industry has pushed supposed limits of physics and technology further and further. Nevertheless, it has long been clear that classic semiconductor technology cannot continue to develop linearly forever through mere miniaturization. What was still science fiction yesterday is coming within reach in the search for alternatives: Computers that are „knitted“ similarly to the human brain, computers that can crack almost any code, and the like.



READ THE ENTIRE
ARTICLE ONLINE

Brain-inspired computing

To this day, the „Von Neumann architecture“, which strictly separates signal processing and memory, dominates the world of digital computers. To achieve higher performance, engineers are packing the components in these computers more densely and clocking them higher and higher. The disadvantages include high power consumption - which could overtax the batteries of future autonomous electric cars - and cumbersome „back and forth“ movement of data between the computing unit and memory.

Evolution has „worked out“ a more economical and efficient principle: The brain uses its neurons equally to store information and to process it. Some tasks that a human brain can solve in the blink of an eye with a power consumption of 20 watts, today's digital computers often manage only approximately as well - and often suck up 1000 watts or more in the process.

Neural networks simulate these brain principles, at least in part, via software on classic silicon digital computers. They are used primarily for the training and work of „artificial intelligences“ (AI). For example, when we start an Internet search query today, a Google neural network is usually pondering in the background.

But there is more to it than that. Find out online how neuromorphic networks reproduce brain structures - at least to some extent - how far brain-like solutions have already come, what Saxon scientists are currently working on in the fields of quantum computing and quantum communication, sensor technology, chipleths and automotive, and what tomorrow's energy systems will look like.

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European Chips Act: Good, but good enough?



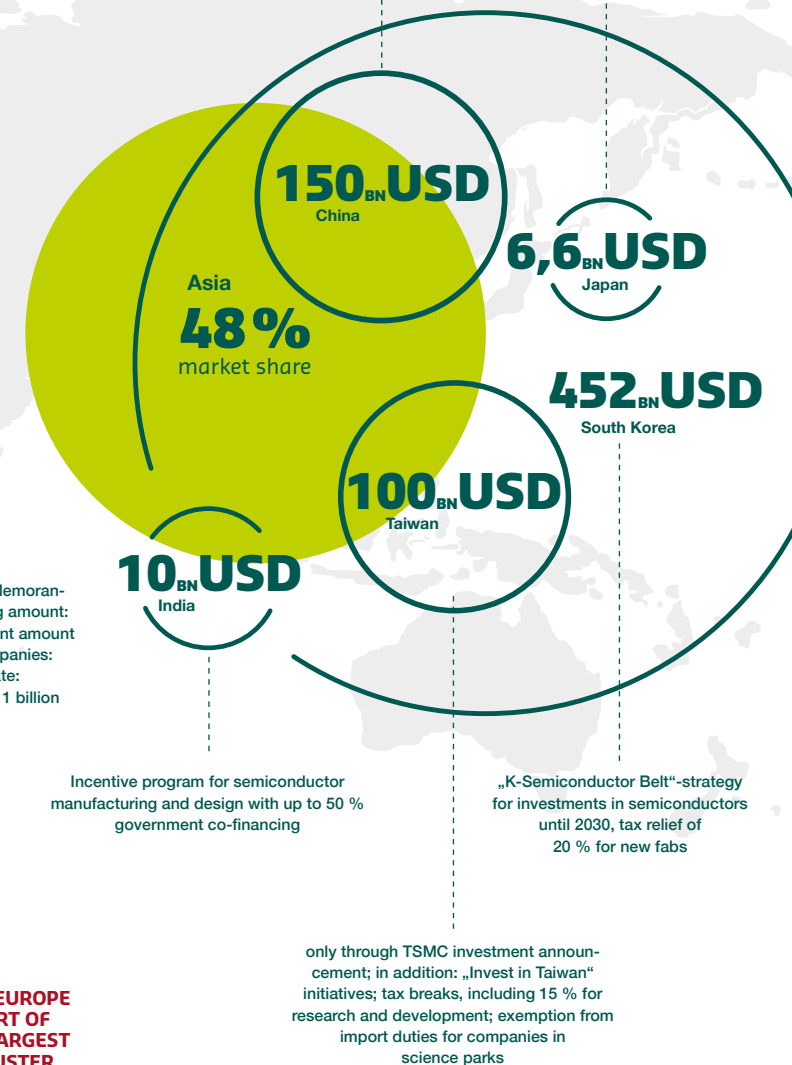
READ MORE ABOUT CONCRETE MEASURES, THE CURRENT STATUS QUO AND WHAT EUROPE CAN EXPECT FROM THE CHIPS ACT IN THE COMING YEARS



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more tax incentives for corporate profits and imported equipment for sub-28nm, sub-65nm and sub-130nm technology nodes

Domestic semiconductor investment, of which 80 % for state-of-the-art fabs; up to 50 % subsidy of Set-up costs



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ELECTRICAL ENGINEERING

Fraunhofer Institute for Electronic Nano Systems ENAS

- AI, Computer Vision, Software Developer (m/f/div)

Bosch Sensortec GmbH

- Project Manager ASIC Development (m/f/div)
- Test Engineer for ASIC Development (m/f/div)
- System Engineer for Inertial Sensors (m/f/div)

ebee Engineering GmbH

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- Development Engineer Software eMobility (m/f/div)
- Requirements Engineer eMobility (m/f/div)

Infineon Technologies Dresden GmbH & Co. KG

- Maintenance technician (m/f/div)

IT

Siltronic AG

- Software Engineer MES Automation (m/f/div)
- License Manager (m/f/div)

Infineon Technologies Dresden GmbH & Co. KG

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- Process Engineers / Engineers Process Technology (m/f/div)

Siltronic AG

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Entegris GmbH

- Customer Service Representative (m/f/div)
- Logistics Specialist Trade Compliance (m/f/div)
- Sr. Account Manager | Semiconductor (m/f/div)

Infineon Technologies Dresden GmbH & Co. KG

- Specialist (m/f/div)

Let's connect, exchange
and grow together!



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Silicon Saxony Alumni

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who have shaped and/or
experienced the history of
Saxon microelectronics!



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